

Features

- Ultra-Small Surface Mount Package (1.0 x 0.8mm)
- Ultra-Low Profile Package (0.45mm)
- Ultra Low Leakage Current (5nA @ $V_R = 75V$)
- Low Capacitance
- Ideal for Battery Powered Portable Applications
- **Lead Free By Design/RoHS Compliant (Note 1)**
- **Halogen and Antimony Free "Green" Device (Notes 2 & 3)**

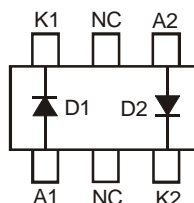
Mechanical Data

- Case: SOT963
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish – Matte Tin Annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.003 grams (Approximate)

SOT963



Top View



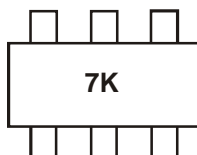
Internal Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
BAS116UDJ-7	SOT963	10,000/Tape & Reel

- Notes:
1. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. No purposely added lead.
 2. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 3. Diodes Inc.'s "Green" policy can be found on our website at <http://www.diodes.com>.
 4. For packaging details, go to our website at <http://www.diodes.com>.

Marking Information



7K = Product Type Marking Code

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	85	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	60	V
Forward Continuous Current (Note 5)	I _{FM}	215	mA
Repetitive Peak Forward Current	I _{FRM}	500	mA
Non-Repetitive Peak Forward Surge Current	I _{FSM}	4.0	A
		1.0	
		0.5	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	250	mW
Thermal Resistance Junction to Ambient Air (Note 5)	R _{θJA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	85	—	—	V	I _R = 100μA
Forward Voltage	V _F	—	—	0.95	V	I _F = 1.0mA
				1.05		I _F = 10mA
				1.15		I _F = 50mA
				1.35		I _F = 150mA
Leakage Current (Note 6)	I _R	—	0.9	5.0	nA	V _R = 75V
			16	500	nA	V _R = 75V, T _J = 150°C
Total Capacitance	C _T	—	2	—	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}	—	0.12	3.0	μs	I _F = I _R = 10mA, I _{rr} = 0.1 x I _R , R _L = 100Ω

Notes: 5. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at <http://www.diodes.com>.
6. Short duration pulse test used to minimize self-heating effect.

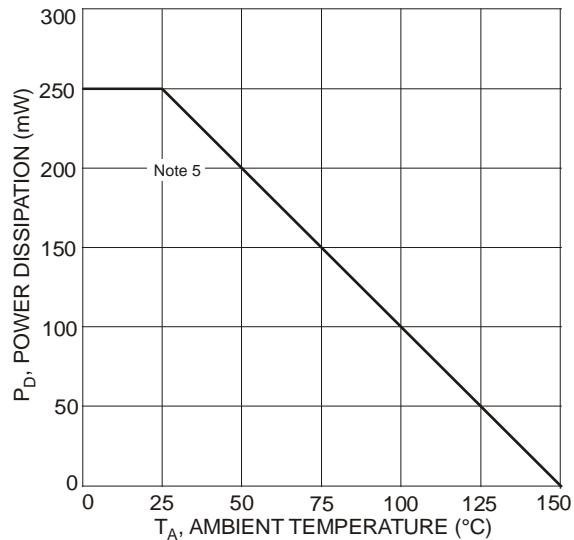


Fig. 1 Power Dissipation vs. Ambient Temperature

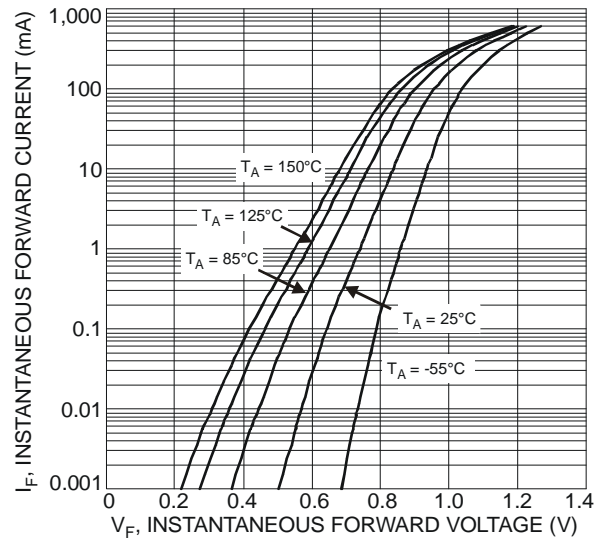


Fig. 2 Typical Forward Characteristics - Per Element

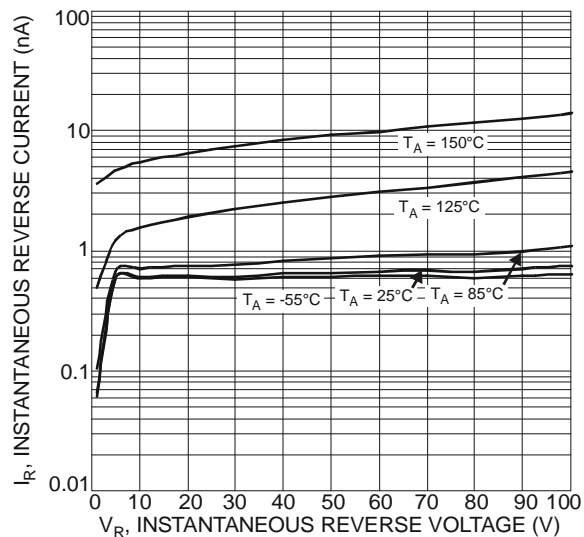


Fig. 3 Typical Reverse Characteristics - Per Element

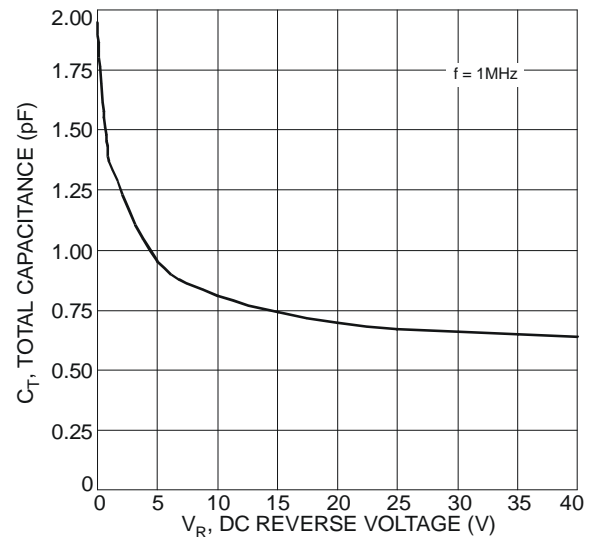
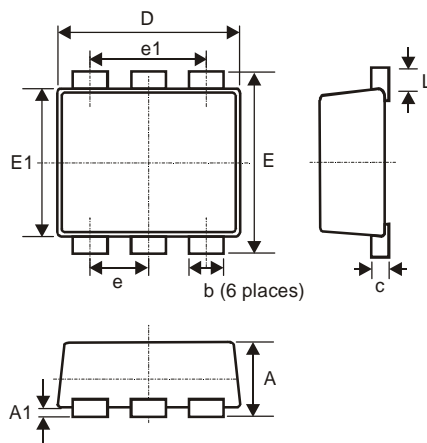


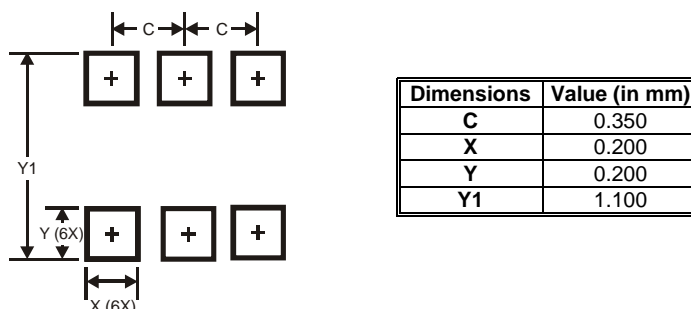
Fig. 4 Typical Total Capacitance vs. Reverse Voltage - Per Element

Package Outline Dimensions



SOT963			
Dim	Min	Max	Typ
A	0.40	0.50	0.45
A1	0	0.05	-
c	0.120	0.180	0.150
D	0.95	1.05	1.00
E	0.95	1.05	1.00
E1	0.75	0.85	0.80
L	0.05	0.15	0.10
b	0.10	0.20	0.15
e	0.35 Typ		
e1	0.70 Typ		
All Dimensions in mm			

Suggested Pad Layout



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